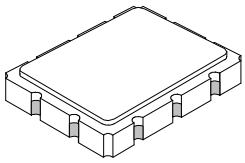
SF1090A

350 MHz SAW Filter

- ***Designed for WLAN IF Applications***
- ***Low Insertion Loss***
- ***9.1 x 7.1 mm Surface-mount Case***
- ***Unbalanced Input and Output***
- ***RFM Standard-Connection Version of SF1090A-1***
- ***Complies with Directive 2002/95/EC (RoHS)***



SM9171-10

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for lead-free soldering - Max. Soldering Profile	260°C for 30 s	

Electrical Characteristics

Characteristic		Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency		f_C	1		350.000		MHz
Passband	Insertion Loss at fc	IL			10	13.0	dB
	1 dB Passband	BW_1	1, 2	±500			kHz
	3 dB Passband	BW_3		±600	±880		
	Group Delay Variation over fc ±600 kHz	GDV			<100	200	ns_{P-P}
Rejection	fc-2.0 to fc-1.8 and fc+1.8 to fc+2.0 MHz		1, 2, 3	30			dB
	fc-7.0 to fc-2.0 and fc+2.0 to fc+7.0 MHz			40			
	At < fc-7.0 MHz and > fc+7.0 MHz			50			
Operating Temperature Range		T_A	1	-20		+70	°C

Impedance Matching to 50 Ω unbalanced	External L-C
Case Style	SM9171-10 9.1 x 7.1 mm Nominal Footprint
Lid Symbolization (XX = 2 character date code)	RFM SF1090A XX

Electrical Connections

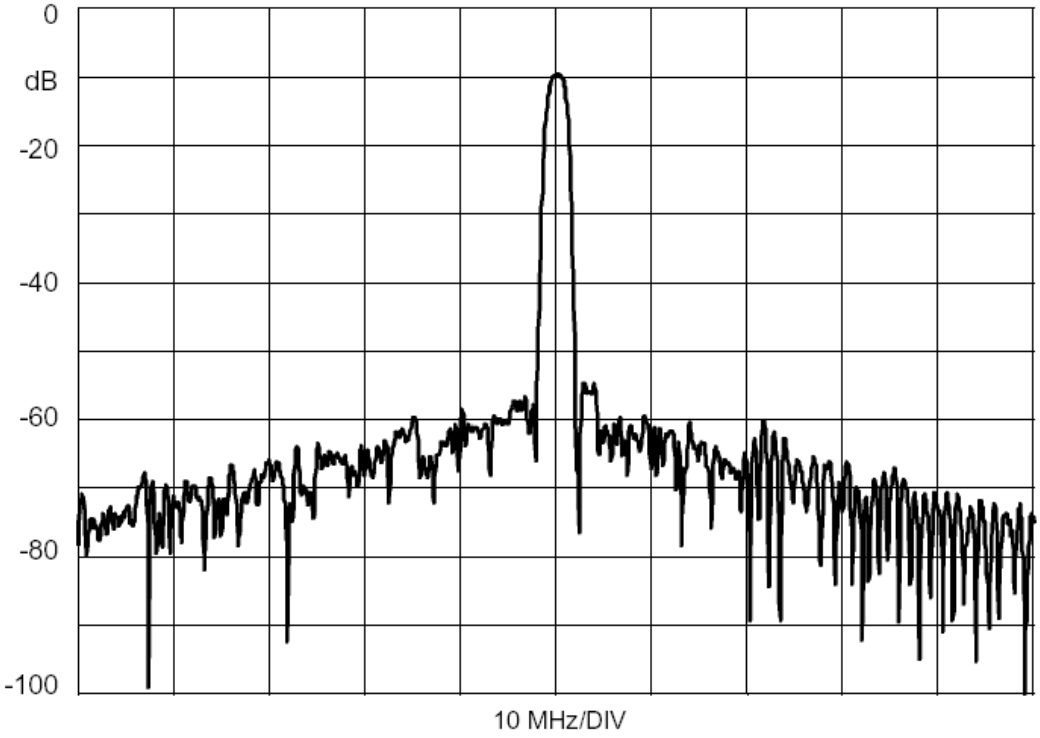
Connection	Terminals
Port 1 Hot	10
Port 1 Gnd Return	1
Port 2 Hot	5
Port 2 Gnd Return	6
Case Ground	All others

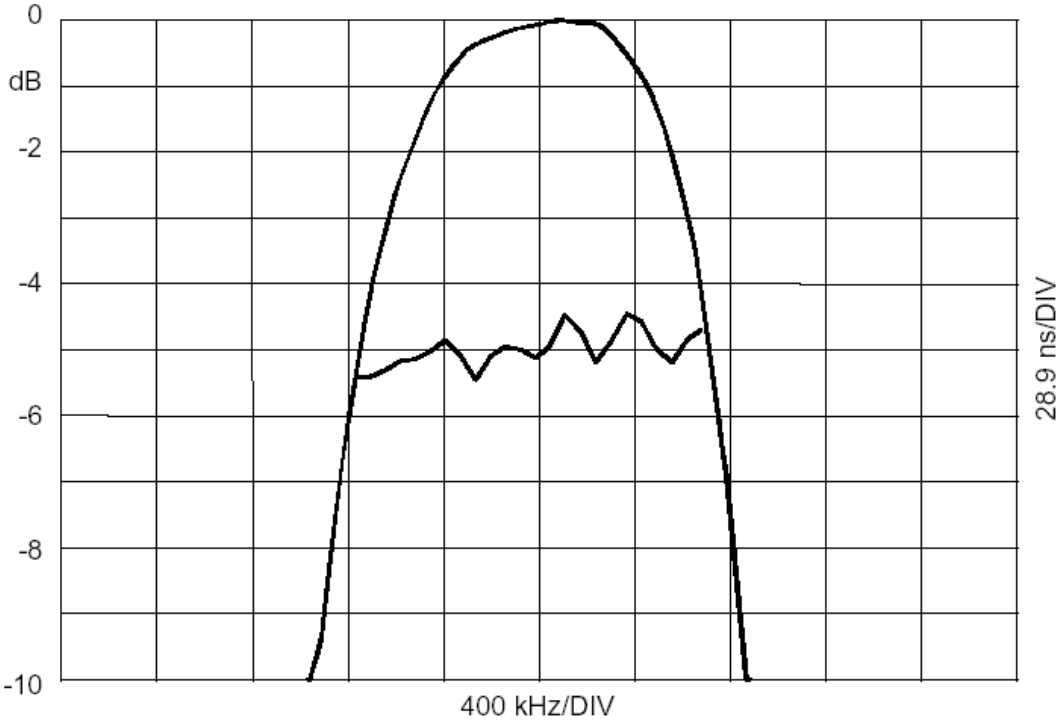
Notes:

1. Unless noted otherwise, all specitication apply over the operating temperature range with filter soldered to the specified demonstration board with impedanced matching to 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specitications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent oon PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. Electrostatic Sensitive Device. Observe precautions for handling.

RF Monolithics, Inc. Phone: (972) 233-2903 Fax: (972) 387-9148 E-mail: info@rfm.com
RFM Europe Phone: 44 1963 251383 Fax: 44 1963 251510 http://www.rfm.com

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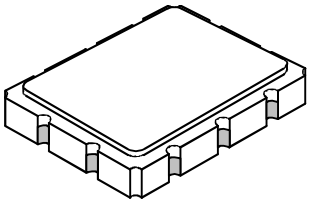




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SM9171-10 Case

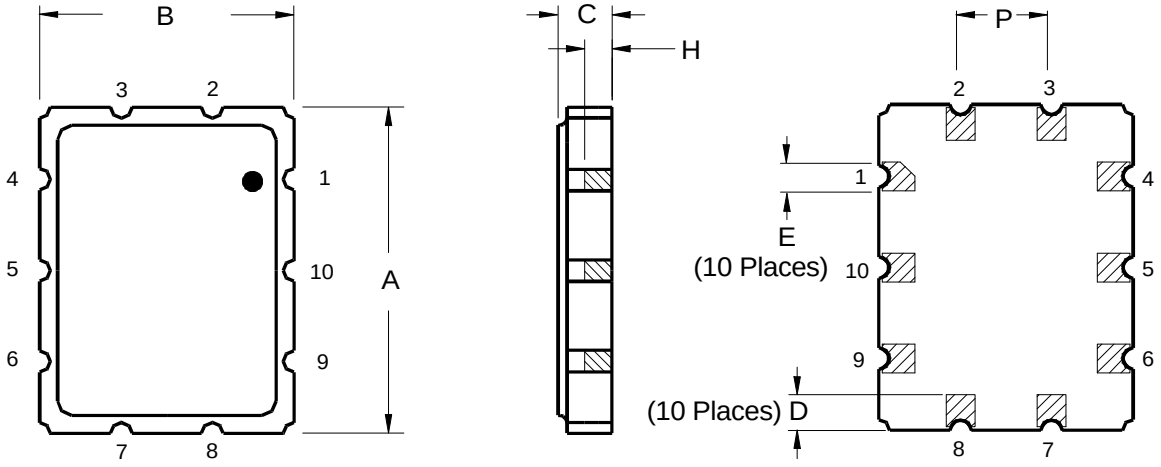
10-Terminal Ceramic Surface-Mount Case
9.1 x 7.1 mm Nominal Footprint



Case Dimensions						
Dimension	**mm**			**Inches**		
	Min	**Nom**	**Max**	**Min**	**Nom**	**Max**
A	8.86	9.09	9.40	0.349	0.358	0.370
B	6.88	7.11	7.40	0.271	0.280	0.291
C		1.91	2.00		0.075	0.079
D		0.99			0.039	
E		0.79			0.031	
H		1.0			0.039	
P		2.54			0.100	

Materials	
Solder Pad Termination	Au plating 30 - 60 µinches (76.2-152 µm) over 80-200 µinches (203-508 µm) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick
Body	Al_2O_3 Ceramic
Pb Free	

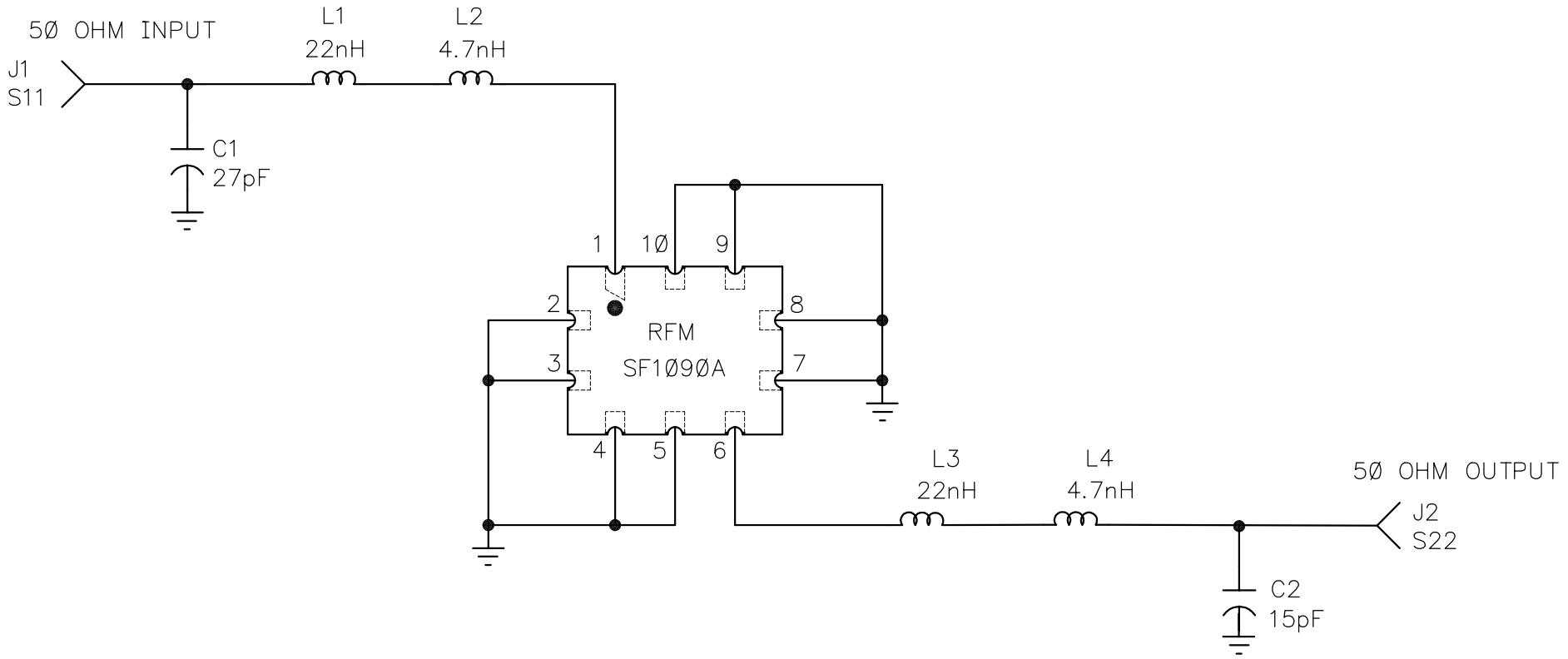
Electrical Connections		
Connection		**Terminals**
Port 1	Input or Return	6
	Return or Input	5
Port 2	Output or Return	1
	Return or Output	10
Ground		All others
Single Ended Operation		**Return is ground**
Differential Operation		**Return is hot**



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NOTES:

REV	ECN NO.	DESCRIPTION	APP/DATE
A	8982	INITIAL RELEASE	28augØØ



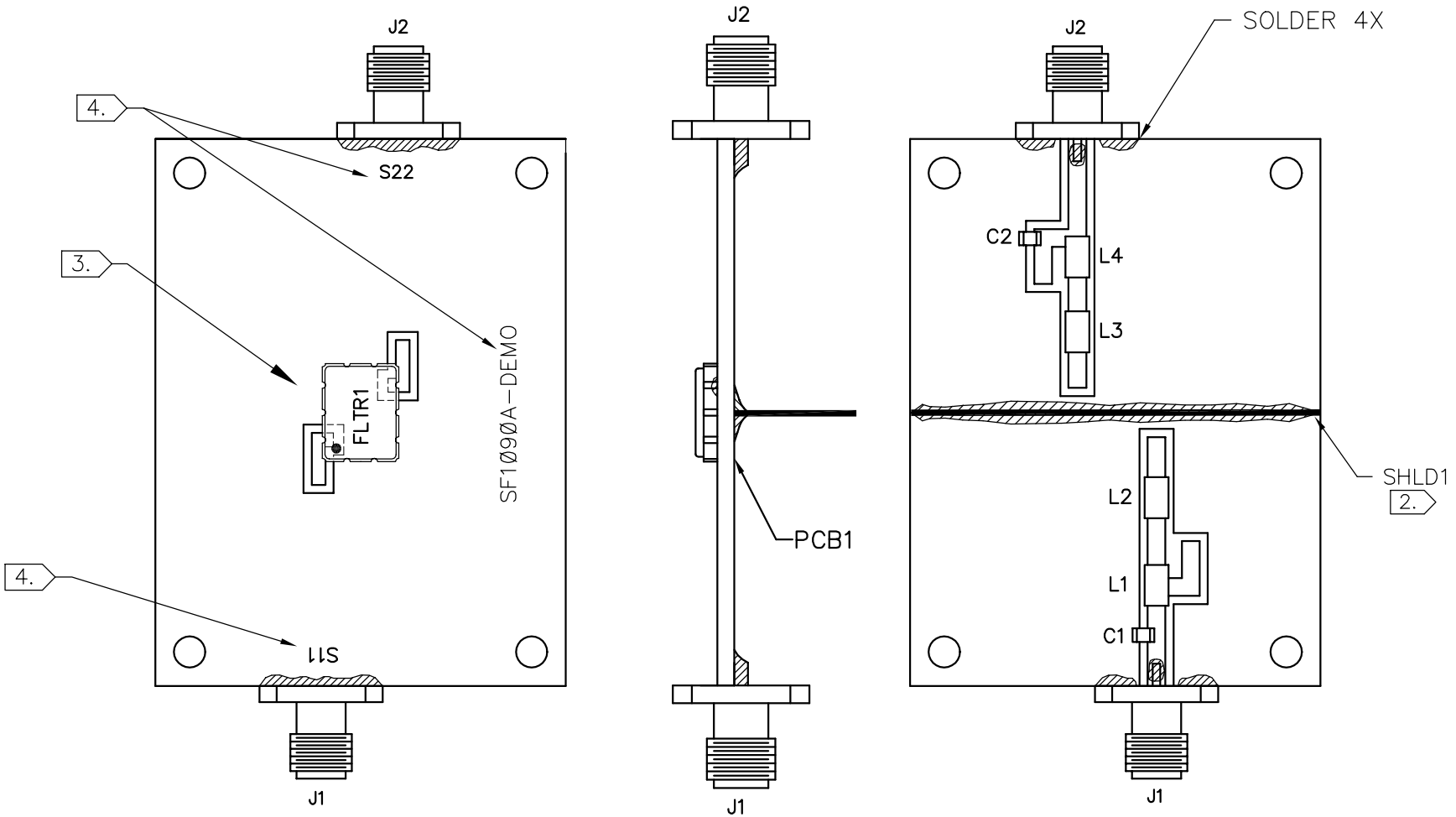
SCHEMATIC

D.U.T. VIEWED FROM TOP

DRAWN BY/DATE: J.F.Christopherson 28augØØ		TITLE: ASSEMBLY DIAGRAM, SF1Ø9ØA–DEMO				
RF Monolithics, Inc. DALLAS, TEXAS 75244		SIZE A	CODE IDENT 2U874	DWG. NO. SF1Ø9ØA–ØØØ	REV A	SHEET 1/3

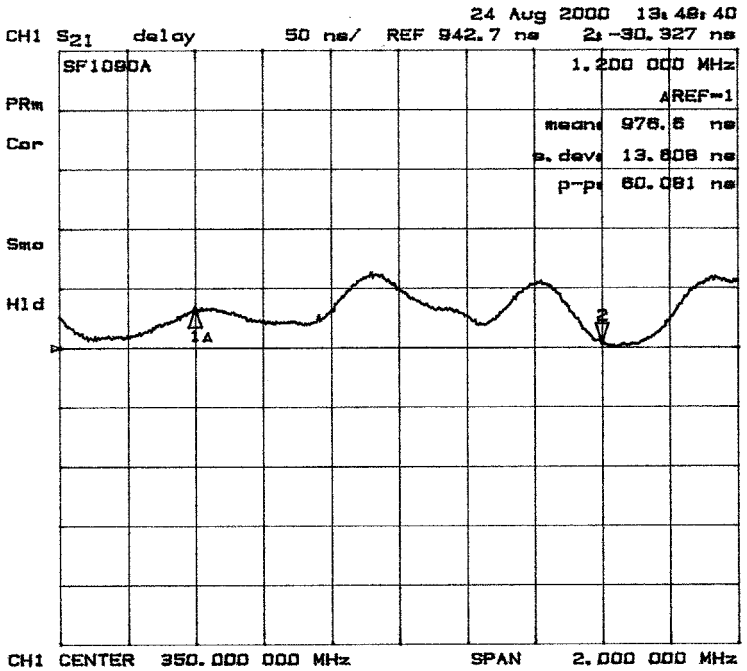
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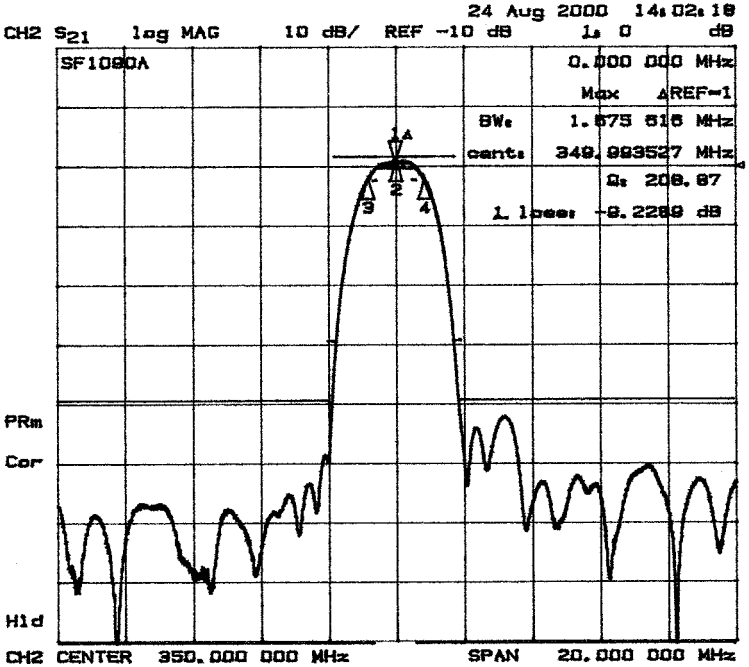
1. SOLDER MOUNT COMPONENTS AND CONNECTORS TO PCB1
2. SOLDER SHLD1 AS SHOWN AND TRIM TAB FROM SHIELD SO THAT IT IS FLUSH WITH PCB.
3. ORIENT THE FLTR1 AND SOLDER IT DOWN TO THE BOARD AS SHOWN
4. LABEL AS SHOWN.

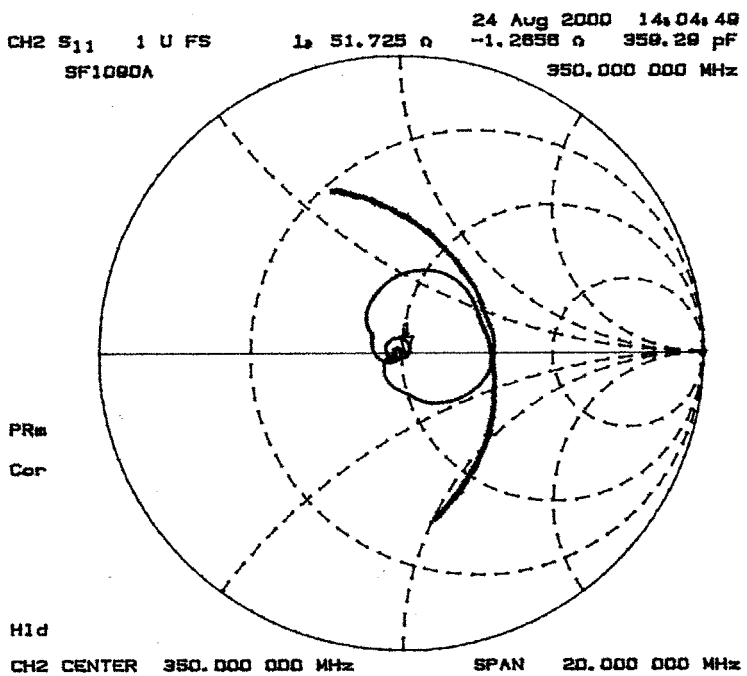


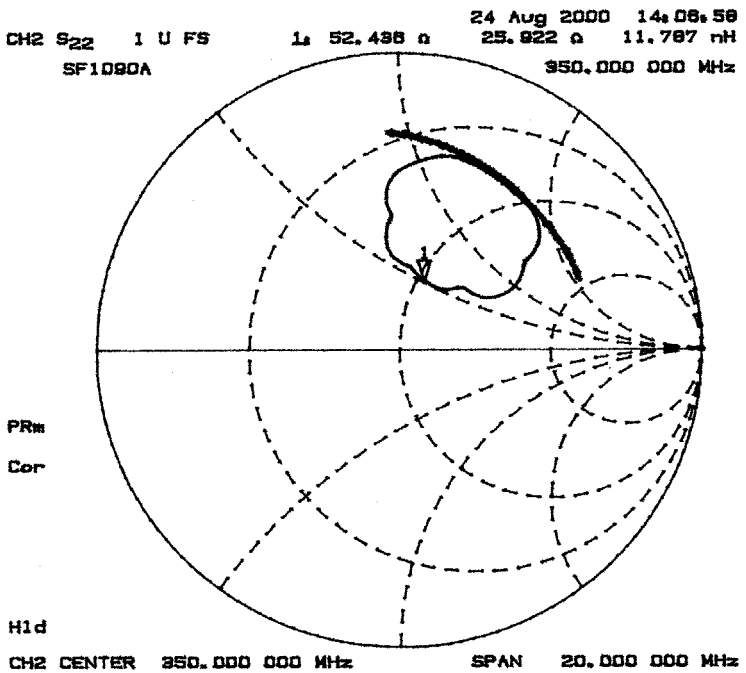
RF Monolithics, Inc. DALLAS, TEXAS 75244		SIZE A	CODE IDENT 2U874	DWG. NO. SF1090A-000	REV A	SHEET 2

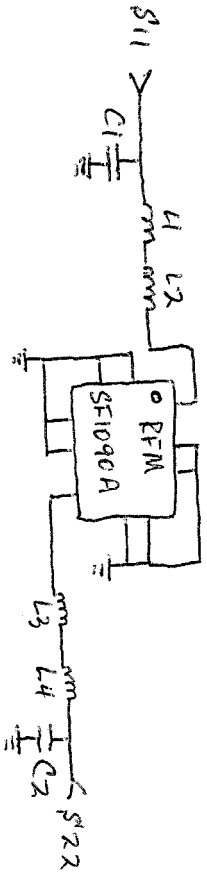
SF1090A
Demo Brd #1
8-24-00
RT











C1=27pf
C2=15pf
L1, L3 = 22nH
L2, L4 = 4.7nH